



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

In re Application of:

Abbott et al.

Atty. Docket: TI-33737A

Serial No.: 10//762,122

Art Unit: 2812

Filed: 01/20/2004

Examiner: Scott Geyer

For: **SEMICONDUCTOR LEADFRAMES PLATED WITH THICK  
NICKEL, MINIMUM PALLADIUM AND PURE TIN**

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF MAILING 37 CFR §1.8(a)**

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on the date indicated below.

7-5-2005  
*Jackie McBride*  
Jackie McBride

**LETTER TO THE OFFICIAL DRAFTSPERSON**

Sir:

Please replace the drawings now on file with the enclosed set of four (4) sheets of replacement formal drawings in the patent application referenced above.

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Respectfully submitted,

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